Disconnect Switch Thermal-Electrical Study of a 'y with a Piezoelectric Actuator

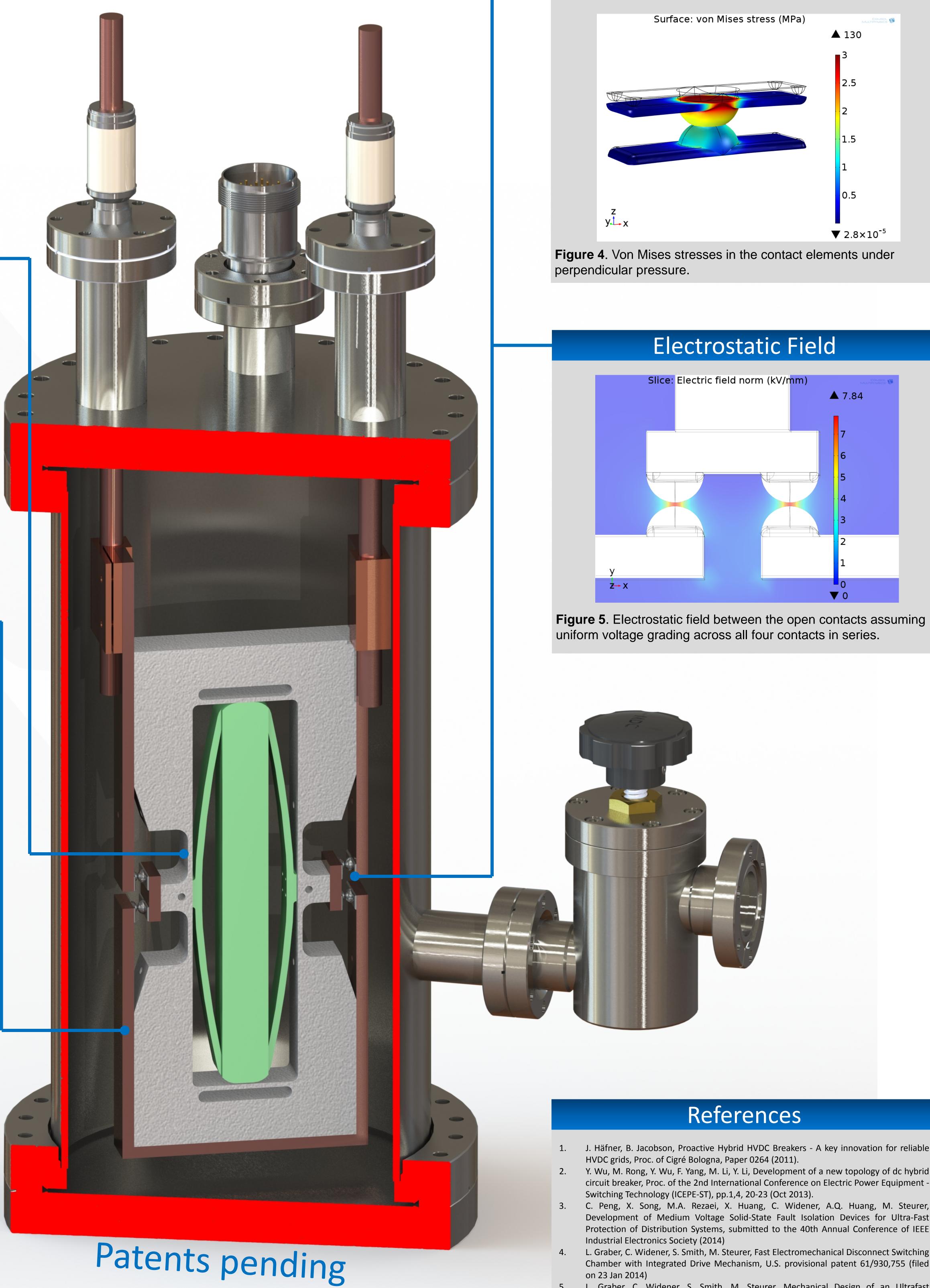
L. Graber¹, C. Widener¹, S. Smith¹, M. Steurer¹

0 h Tallahassee, FL, USA . V

Introduction

• High speed disconnect switch

- 15 kV_{RMS}, 200 A, 50-60 Hz
- Opening in < 1 ms
- Losses in on-state: < 5 W
- Applications:



- Power electronics based distribution systems
- Hybrid circuit breaker (in combination with semiconductors)

Static Mechanical Stress

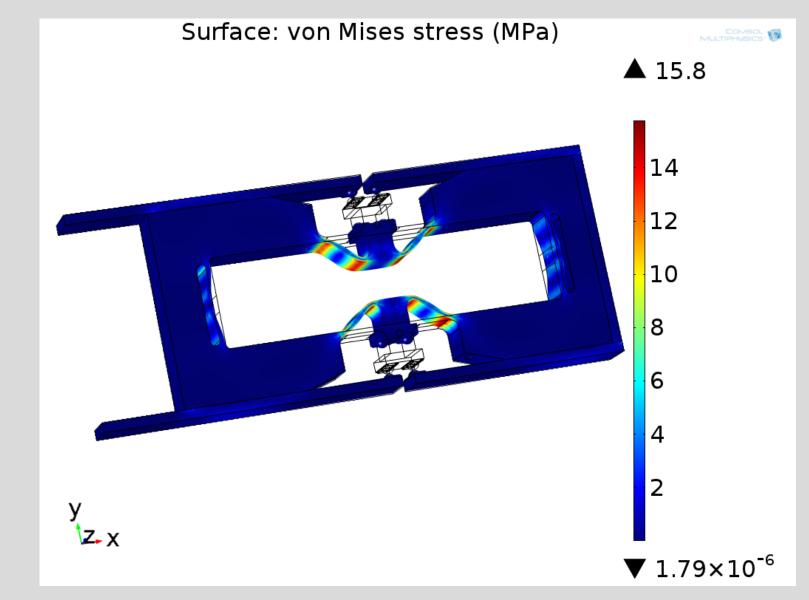


Figure 1. Von Mises stresses in the insulator frame while the piezoelectric stack expands and the contacts retract.

Static Contact Deformation

Losses and Peak Temperature

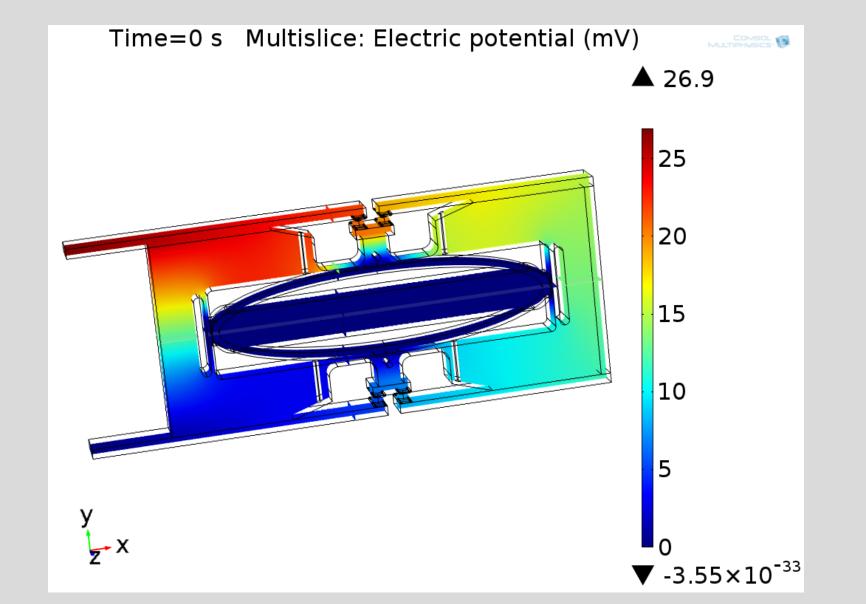


Figure 2. Voltage potential field at 200 A, resulting in a total voltage drop of 26.6 mV (approx. 5 W).

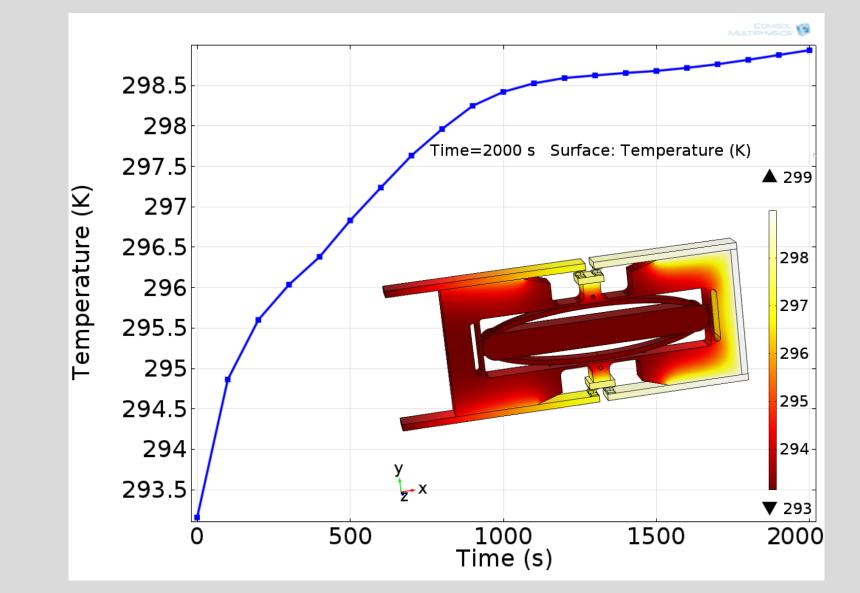


Figure 3. Peak temperature as a function of time and thermal field after 2000 s (insert).

Acknowledgement

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